ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	All rights reserved u ntions.	nder both	This docume level parts, t	ent is a declar he declaratio	ration of n encon	f the substance npasses all lov	es within wer level	the manufactu materials for y	urer listed in which the m	tem. N nanufao	ote: if the	e item is an as s engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and M	ials and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Respons	Response Date*					
nsemi										2024-05-02					
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Produc	Product-Env-Stewards@onsemi.com				
authorized Representative*	Title - Representative			Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Iter	n Number	Mfr Item Name			Effective Da	ate V	ersion Manufacturing S		cturing Site	,	Weight	t*	UOM	Unit Type
	CAT80	ZTBI-GT3	SUP, PUSH-PULL, ACT LOW			2024-05-02			тнв		:	14.1		mg	Each
Anufacturing Proccess Informa	ation								-						I
Terminal Plating / Grid Array M	Iaterial	Terminal Base	Alloy J	J-STD-020 MSL Rati		Peak Process E		Body Temperature Max Time at Peal		k Temperat	Temperature Numbe		of Reflow Cyc	les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		C	30	30		seconds 3			
omments															
evel 1 - maximum time at peak temperat	ure during so	oldering is 10-3	0 seconds												
or more information regarding materia	l composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ohthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.15	mg	Supplier	Silicon (Si)	7440-21-3		0.15	mg
Die Attach	1.0E-4	mg		Epoxy resin	proprietary data		0	mg
			Supplier	Fatty acids, C18-unsatd., dimers, polymers with epichlorhydrin	68475-94-5		0	mg
			Supplier	2,2'-[[2-(oxiranylmethoxy)-1,3- phenylene]bis(methylene)]bisoxirane	13561-08-5	561-08-5		mg
			Supplier	4-Methyl-2-Phenyl-1H-Imidazole	827-43-0		0	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0	mg
Lead Frame	0.7943	mg	Supplier	Zinc (Zn)	7440-66-6		0.001	mg
			Supplier	Iron (Fe)	7439-89-6		0.0187	mg
			Supplier	Copper (Cu)	7440-50-8		0.7744	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0002	mg
Mold Compound-Black	13.11	mg		Epoxy resin	proprietary data		0.6555	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2622	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.3277	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0655	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.799	mg
Plating	0.008	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			В	Nickel (Ni)	7440-02-0		0.0076	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
Wire Bond - Au	0.0376	mg	Supplier	Gold (Au)	7440-57-5		0.0376	mg